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INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Field Device Integration (FDI)[®] –
Part 103-1: Profiles – PROFIBUS**

**Intégration des appareils de terrain (FDI)[®] –
Partie 103-1: Profils – PROFIBUS**





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IEC 62769-103-1 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This third edition cancels and replaces the second edition published in 2020. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added DEVICE_ID to the ProfibusIdentificationType and namespace to Annex A and Annex B;
- b) added mapping from PB standard parameters to PA DIM.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/862/CDV	65E/919/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

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